

MOSFET – Power, Single N-Channel, SO8FL 40 V, 3.1 mΩ, 83 A

NTMFS3D1N04XM

Features

- Low R_{DS(on)} to Minimize Conduction Losses
- Low Capacitance to Minimize Driver Losses
- Small Footprint (5 x 6 mm) with Compact Design
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

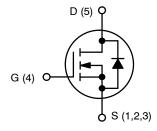
- Motor Drive
- Battery Protection
- Oring

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V _{DSS}	40	V
Gate-to-Source Voltage DC		DC	V _{GS}	±20	V
Continuous Drain		T _C = 25°C	I _D	83	Α
Current	Steady State	T _C = 100°C	1	58	
Power Dissipation		T _C = 25°C	P _D	39	W
Continuous Drain	Steady	T _A = 25°C	I _D	25	Α
Current R _{θJA}	State	T _A = 100°C		18	
Pulsed Drain Current $ T_{A} = 25^{\circ}C, \\ t_{p} = 10 \; \mu s $			I _{DM}	506	Α
Operating Junction and Storage Temperature Range			T _J , T _{stg}	–55 to 175	°C
Source Current (Body Diode)			Is	55	Α
Single Pulse Drain-to-Source Avalanche Energy (I _{L(pk)} = 4.6 A)			E _{AS}	133	mJ
Lead Temperature Soldering Reflow for Soldering Purposes (1/8" from case for 10 s)			TL	260	°C

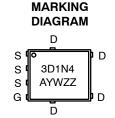
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX	
40 V	3.1 m Ω @ 10 V	83 A	



N-CHANNEL MOSFET





3D1N4 = Specific Device code A = Assembly Location

Y = Year
W = Work Week
ZZ = Lot Traceability

ORDERING INFORMATION

See detailed ordering, marking and shipping information on page 5 of this data sheet.

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case (Note 2)	$R_{ heta JC}$	3.79	°C/W
Thermal Resistance, Junction-to-Ambient (Notes 1, 2)	$R_{\theta JA}$	41.6	

^{1.} Surface-mounted on FR4 board using 650 mm², 2 oz Cu pad.

ELECTRICAL CHARACTERISTICS (T_{.1} = 25°C unless otherwise specified)

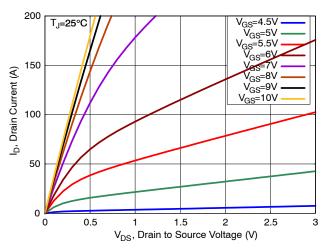
Parameter	Symbol	Test Condition	Min	Тур	Max	Unit	
OFF CHARACTERISTICS			•		•		
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}, T_J = 25^{\circ}\text{C}$	40			V	
Drain-to-Source Breakdown Voltage Temperature Coefficient	$\Delta V_{(BR)DSS}/ \Delta T_J$	I _D = 1 mA, Referenced to 25°C		15		mV/°C	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 40 V, T _J = 25°C			10	μΑ	
		V _{DS} = 40 V, T _J = 125°C			100	1	
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS} = 20 V			100	nA	
ON CHARACTERISTICS							
Drain-to-Source On Resistance	R _{DS(on)}	$V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}, T_J = 25^{\circ}\text{C}$		2.7	3.1	mΩ	
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}$, $I_D = 40 \mu A$, $T_J = 25^{\circ} C$	2.5		3.5	V	
Gate Threshold Voltage Temperature Coefficient	$\Delta V_{GS(TH)}/ \Delta T_J$	$V_{GS} = V_{DS}$, $I_D = 40 \mu A$		-7.2		mV/°C	
Forward Transconductance	9FS	V _{DS} = 5 V, I _D = 20 A		79.6		S	
CHARGES & CAPACITANCES				-			
Input Capacitance	C _{ISS}	V _{DS} = 20 V, V _{GS} = 0 V, f = 1 MHz		1002		pF	
Output Capacitance	Coss			717			
Reverse Transfer Capacitance	C _{RSS}			18.4			
Total Gate Charge	Q _{G(TOT)}	V _{DD} = 20 V, I _D = 50 A, V _{GS} = 10 V		15.6		nC	
Threshold Gate Charge	Q _{G(TH)}			2.94			
Gate-to-Source Charge	Q _{GS}			4.82			
Gate-to-Drain Charge	Q_{GD}			2.84			
Gate Resistance	R_{G}	f = 1 MHz		1.0		Ω	
SWITCHING CHARACTERISTICS (Note 3)						
Turn-On Delay Time	t _{d(ON)}	Resistive Load, V _{GS} = 0/10 V,		13.8		ns	
Rise Time	t _r	V_{DD} = 20 V, I_{D} = 50 A, R_{G} = 0 Ω		4.6		-	
Turn-Off Delay Time	t _{d(OFF)}			18.8			
Fall Time	t _f			4.15			
DRAIN-SOURCE DIODE CHARACTERIS	TICS					-	
Forward Diode Voltage	V _{SD}	$V_{GS} = 0 \text{ V, } I_S = 20 \text{ A, } T_J = 25^{\circ}\text{C}$		0.82	1.2	V	
		V _{GS} = 0 V, I _S = 20 A, T _J = 125°C		0.67			
Reverse Recovery Time	t _{RR}	$V_{GS} = 0 \text{ V}, I_{S} = 50 \text{ A},$		29		ns	
Charge Time	ta	di/dt = 100 A/μs, V _{DD} = 20 V		11.3		ns	
Discharge Time	t _b			17.8		ns	
Reverse Recovery Time	Q _{RR}			14.5		nC	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

3. Switching characteristics are independent of operating junction temperatures

^{2.} The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

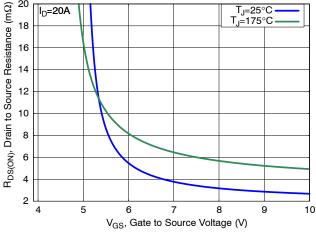
TYPICAL CHARACTERISTICS



200 180 160 (4) 140 120 100 80 20 40 20 1 = 25°C T_j=25°C T_j=175°C V_{GS}, Gate to Source Voltage (V)

Figure 1. On-Region Characteristics

Figure 2. Transfer Characteristics



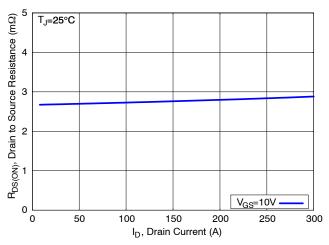
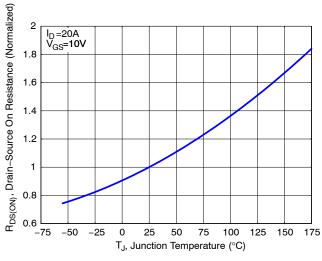


Figure 3. On-Resistance vs. Gate Voltage

Figure 4. On-Resistance vs. Drain Current



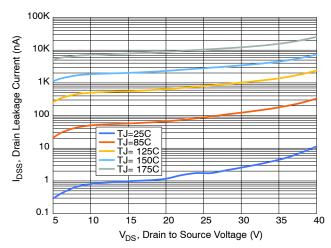


Figure 5. Normalized ON Resistance vs. Junction Temperature

Figure 6. Drain-to-Source Leakage Current vs. Voltage

TYPICAL CHARACTERISTICS

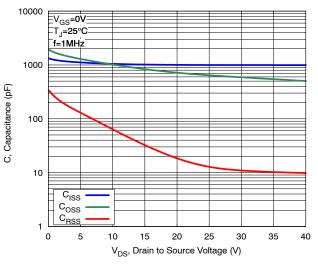


Figure 7. Capacitance Characteristics

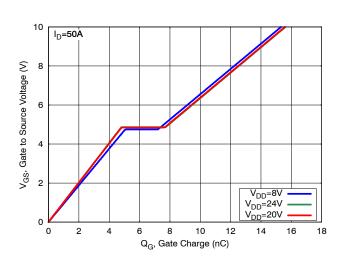


Figure 8. Gate Charge Characteristics

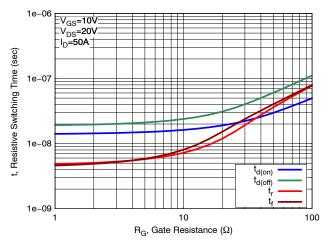


Figure 9. Resistive Switching Time Variation vs. Gate Resistance

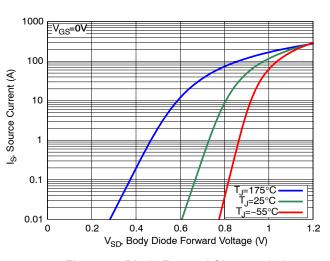


Figure 10. Diode Forward Characteristics

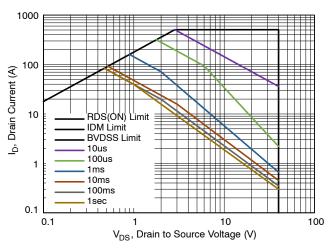


Figure 11. Safe Operating Area (SOA)

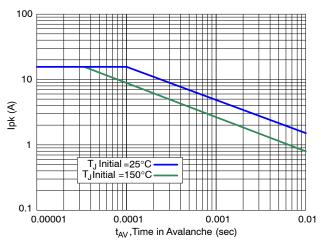


Figure 12. Ipeak vs. Time in Avalanche

TYPICAL CHARACTERISTICS

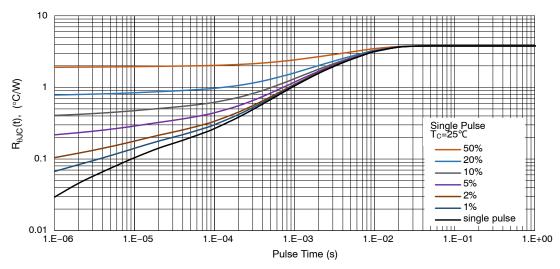


Figure 13. Transient Thermal Response

DEVICE ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
NTMFS3D1N04XMT1G	3D1N4	DFN5 (Pb-Free)	1500 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.





DFN5 5x6, 1.27P (SO-8FL) CASE 488AA ISSUE N

DATE 25 JUN 2018

NOTES:

- DIMENSIONING AND TOLERANCING PER
- ASME Y14.5M, 1994. CONTROLLING DIMENSION: MILLIMETER. DIMENSION D1 AND E1 DO NOT INCLUDE
- MOLD FLASH PROTRUSIONS OR GATE BURRS

	MILLIMETERS			
DIM	MIN	NOM	MAX	
Α	0.90	1.00	1.10	
A1	0.00		0.05	
b	0.33	0.41	0.51	
С	0.23	0.28	0.33	
D	5.00	5.15	5.30	
D1	4.70	4.90	5.10	
D2	3.80	4.00	4.20	
E	6.00	6.15	6.30	
E1	5.70	5.90	6.10	
E2	3.45	3.65	3.85	
е	1.27 BSC			
G	0.51	0.575	0.71	
K	1.20	1.35	1.50	
L	0.51	0.575	0.71	
L1	0.125 REF			
M	3.00	3.40	3.80	
θ	0 °		12 °	

GENERIC MARKING DIAGRAM*

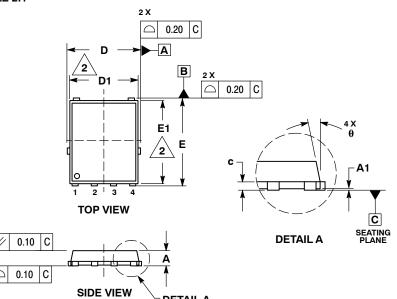


XXXXXX = Specific Device Code

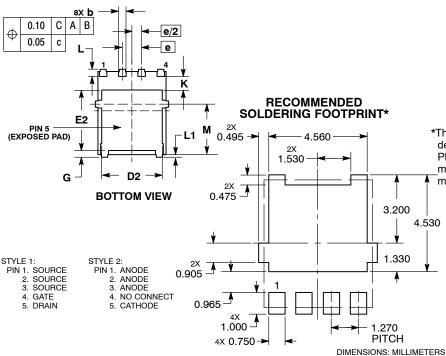
= Assembly Location Α

Υ = Year W = Work Week = Lot Traceability ZZ

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present. Some products may not follow the Generic Marking.



DETAIL A



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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